

## 3.3 VOLT CMOS SyncFIFO<sup>™</sup> 64 x 36

## FEATURES:

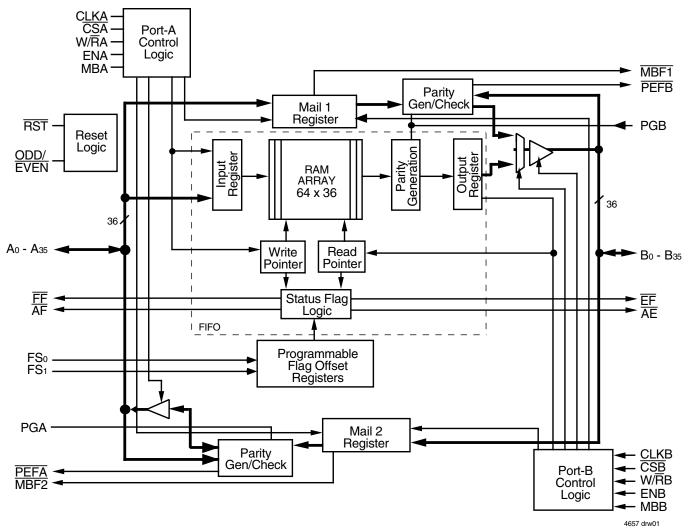
- 64 x 36 storage capacity
- Supports clock frequencies up to 67MHz
- Fast access times of 10ns
- Free-running CLKA and CLKB may be asynchronous or coincident (permits simultaneous reading and writing of data on a single clock edge)
- Synchronous data buffering from Port A to Port B
- Mailbox bypass register in each direction
- Programmable Almost-Full (AF) and Almost-Empty (AE) flags
- Microprocessor Interface Control Logic
- Full Flag (FF) and Almost-Full (AF) flags synchronized by CLKA
- Empty Flag (EF) and Almost-Empty (AE) flags synchronized by CLKB
- · Passive parity checking on each Port
- · Parity Generation can be selected for each Port

# FUNCTIONAL BLOCK DIAGRAM

- Available in space-saving 120-pin Thin Quad Flatpack (PFG)
- Green parts available, see ordering information

# DESCRIPTION:

The IDT72V3611 is designed to run off a 3.3V supply for exceptionally low power consumption. This device is a monolithic, high-speed, low-power, CMOS Synchronous (clocked) FIFO memory which supports clock frequencies up to 67MHz and has read access times as fast as 10ns. The 64 x 36 dualport FIFO buffers data from Port A to Port B. The FIFO operates in IDT Standard mode and hasflags to indicate empty and full conditions, and two programmable flags, Almost-Full ( $\overline{AF}$ ) and Almost-Empty ( $\overline{AE}$ ), to indicate when a selected number of words is stored in memory. Communication between each port can take place through two 36-bit mailbox registers. Each mailbox register has a flag to signal when new mail has been stored. Parity generation can be selected



## COMMERCIAL TEMPERATURE RANGE



# DESCRIPTION (CONTINUED)

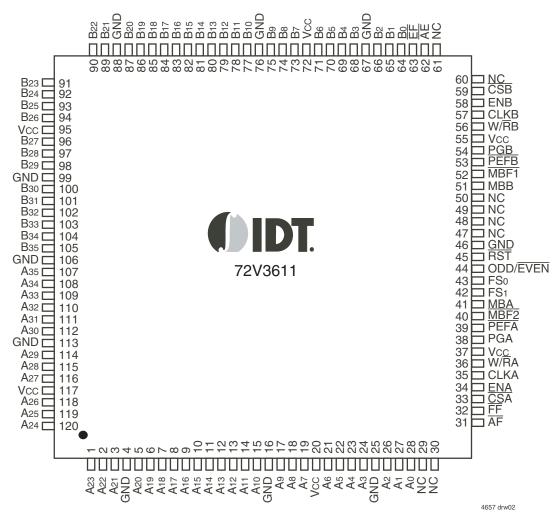
for data read from each port. Two or more devices may be used in parallel to create wider data paths.

The IDT72V3611 is a synchronous (clocked) FIFO, meaning each port employs a synchronous interface. All data transfers through a port are gated to the LOW-to-HIGH transition of a port clock by enable signals. The clocks for each port are independent of one another and can be asynchronous or coincident. The enables for each port are arranged to provide a simple bidirectional interface between microprocessors and/or buses with synchronous control.

The Full Flag ( $\overline{FF}$ ) and Almost-Full ( $\overline{AF}$ ) flag of the FIFO are two-stage synchronized to the port clock that writes data into its array (CLKA). The Empty Flag ( $\overline{EF}$ ) and Almost-Empty ( $\overline{AE}$ ) flag of the FIFO are two-stage synchronized to the port clock that reads data from its array.

The IDT72V3611 is characterized for operation from 0°C to 70°C. This device is fabricated using high speed, submicron CMOS technology.

## PIN CONFIGURATION



NOTES:

1. Pin 1 identifier in corner.

2. NC = No internal connection

TQFP (PNG120, order code: PFG) TOP VIEW



# PIN DESCRIPTION

Symbol	Name	I/O	Description
A0-A35	Port-A Data	I/O	36-bit bidirectional data port for side A.
ĀĒ	Almost-Empty Flag	0	Programmable Almost-Empty flag synchronized to CLKB. It is LOW when the number of words in the FIFO is less than or equal to the value in the offset register, X.
ĀF	Almost-Full Flag	0	Programmable Almost-Full flag synchronized to CLKA. It is LOW when the number of empty locations in the FIFO is less than or equal to the value in the Offset register, X.
B0-B35	Port-B Data.	I/O	36-bit bidirectional data port for side B.
CLKA	Port-A Clock	I	CLKA is a continuous clock that synchronizes all data transfers through port-A and can be asynchronous or coincident to CLKB. FF and AF are synchronized to the LOW-to-HIGH transition of CLKA.
CLKB	Port-B Clock	I	CLKB is a continuous clock that synchronizes all data transfers through port-B and can be asynchronous or coincident to CLKA. EF and AE are synchronized to the LOW-to-HIGH transition of CLKB.
CSA	Port-A Chip Select	I	$\overline{\text{CSA}}$ must be LOW to enable a LOW-to-HIGH transition of CLKA to read or write data on port-A. The A0-A35 outputs are in the high-impedance state when $\overline{\text{CSA}}$ is HIGH.
CSB	Port-B Chip Select	I	CSB must be LOW to enable a LOW-to-HIGH transition of CLKB to read or write data on port-B. The B0-B35 outputs are in the high-impedance state when CSB is HIGH.
Ē	Empty Flag	0	<b>E</b> F is synchronized to the LOW-to-HIGH transition of CLKB. When <b>E</b> F is LOW, the FIFO is empty, and reads from its memory are disabled. Data can be read from the FIFO to its output register when <b>E</b> F is HIGH. <b>E</b> F is forced LOW when the device is reset and is set HIGH by the second LOW-to-HIGH transition of CLKB after data is loaded into empty FIFO memory.
ENA	Port-A Enable		ENA must be HIGH to enable a LOW-to-HIGH transition of CLKA to read or write data on port-A.
ENB	Port-B Enable		ENB must be HIGH to enable a LOW-to-HIGH transition of CLKB to read or write data on port-B.
FF	Full Flag	0	FF is synchronized to the LOW-to-HIGH transition of CLKA. When FF is LOW, the FIFO is full, and writes to its memory are disabled. FF is forced LOW when the device is reset and is set HIGH by the second LOW-to-HIGH transition of CLKA after reset.
FS1, FS0	Flag-Offset Selects	I	The LOW-to-HIGH transition of $\overline{RST}$ latches the values of FS0 and FS1, which loads one of four preset values into the Almost-Full and Almost-Empty Offset register (X).
MBA	Port-A Mailbox Select	I	A HIGH level on MBA chooses a mailbox register for a port-A read or write operation.
MBB	Port-B Mailbox Select	I	A HIGH level on MBB chooses a mailbox register for a port-B read or write operation. When the B0-B35 outputs are active, a HIGH level on MBB selects data from the mail1 register for output, and a LOW level selects the FIFO output register data for output.
MBF1	Mail1 Register Flag	0	MBF1 is set LOW by a LOW-to-HIGH transition of CLKA that writes data to the mail1 register. Writes to the mail1 register are inhibited while MBF1 is set LOW. MBF1 is set HIGH by a LOW-to-HIGH transition of CLKB when a port-B read is selected and MBB is HIGH. MBF1 is set HIGH when the device is reset.
MBF2	Mail2 Register Flag	0	MBF2 is set LOW by a LOW-to-HIGH transition of CLKB that writes data to the mail2 register. Writes to the mail2 register are inhibited while MBF2 is LOW. MBF2 is set HIGH by a LOW-to-HIGH transition of CLKA when a port-A read is selected and MBA is HIGH. MBF2 is set HIGH when the device is reset.
ODD/ EVEN	Odd/Even Parity Select	I	Odd parity is checked on each port when ODD/EVEN is HIGH, and even parity is checked when ODD/EVEN is LOW. ODD/EVEN also selects the type of parity generated for each port if parity generation is enabled for a read operation.
PEFA	Port-A Parity Error Flag	O [Port A)	When any byte applied to terminals A0-A35 fails parity, PEFA is LOW. Bytes are organized as A0-A8, A9-A17, A18-A26, and A27-A35, with the most significant bit of each byte serving as the parity bit. The type of parity checked is determined by the state of the ODD/EVEN input. The parity trees used to check the A0-A35 inputs are shared by the mail2 register to generate parity if parity generation is selected by PGA. Therefore, if a mail2 read with parity generation is setup by having CSA LOW, ENA HIGH, W/RA LOW, MBA HIGH, and PGA HIGH, the PEFA flag is forced HIGH regardless of the state of A0-A35 inputs.



# PIN DESCRIPTION (CONTINUED)

Symbol	Name	I/O	Description
PEFB	Port-B Parity Error Flag	O (Port B)	When any byte applied to terminals B0-B35 fails parity, PEFB is LOW. Bytes are organized as B0-B8, B9-B17, B18-B26, B27-B35, with the most significant bit of each byte serving as the parity bit. The type of parity checked is determined by the state of the ODD/EVEN input. The parity trees used to check the B0-B35 inputs are shared by the mail1 register to generate parity if parity generation is selected by PGB. Therefore, if a mail1 read with parity generation is setup by having CSB LOW, ENB HIGH, W/RB LOW, MBB HIGH, and PGB HIGH, the PEFB flag is forced HIGH regardless of the state of the B0-B35 inputs
PGA	Port-A Parity Generation	I	Parity is generated for mail2 register reads from port A when PGA is HIGH. The type of parity generated is selected by the state of the ODD/EVEN input. Bytes are organized as A0-A8, A9-A17, A18-A26, and A27-A35. The generated parity bits are output in the most significant bit of each byte.
PGB	Port-B Parity Generation	I	Parity is generated for data reads from port B when PGB is HIGH. The type of parity generated is selected by the state of the ODD/EVEN input. Bytes are organized as B0-B8, B9-B17, B18-B26, and B27-B35. The generated parity bits are output in the most significant bit of each byte.
RST	Reset	I	To reset the device, four LOW-to-HIGH transitions of CLKA and four LOW-to-HIGH transitions of CLKB must occur while RST is LOW. This sets the AF, MBF1, and MBF2 flags HIGH and the EF, AE, and FF flags LOW. The LOW-to-HIGH transition of RST latches the status of the FS1 and FS0 inputs to select Almost-Full and Almost-Emptyflag offset.
W/RA	Port-A Write/Read Select	I	A HIGH selects a write operation and a LOW selects a read operation on port A for a LOW-to-HIGH transition of CLKA. The A0-A35 outputs are in the high-impedance state when $W/RA$ is HIGH.
W/RB	Port-B Write/Read Select	I	A HIGH selects a write operation and a LOW selects a read operation on port B for a LOW-to-HIGH transition of CLKB. The B0-B35 outputs are in the high-impedance state when W/RB is HIGH.

# ABSOLUTE MAXIMUM RATINGS OVER OPERATING FREE-AIR TEMPERATURE RANGE (Unless otherwise noted)<sup>(1)</sup>

Symbol	Rating	Commercial	Unit
Vcc	Supply Voltage Range	-0.5 to +4.6	V
VI <sup>(2)</sup>	Input Voltage Range	-0.5 to Vcc+0.5	V
VO <sup>(2)</sup>	Output Voltage Range	-0.5 to Vcc+0.5	V
Ік	Input Clamp Current, (VI < 0 or VI > VCC)	±20	mA
Іок	Output Clamp Current, (Vo = < 0 or Vo > Vcc)	±50	mA
Ιουτ	Continuous Output Current, (Vo = 0 to Vcc)	±50	mA
Icc	Continuous Current Through Vcc or GND	±500	mA
Tstg	Storage Temperature Range	-65 to 150	°C

NOTES:

1. Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

2. The input and output voltage ratings may be exceeded provided the input and output current ratings are observed.

# RECOMMENDED OPERATING

## CONDITIONS

Symbol	Parameter	Min.	Тур.	Max.	Unit
Vcc	Supply Voltage	3.0	3.3	3.6	V
Vih	High-Level Input Voltage	2	_	Vcc+0.5	V
VIL	Low-Level Input Voltage	—	_	0.8	V
Іон	High-Level Output Current	—	_	-4	mA
Iol	Low-Level Output Current	—	—	8	mA
TA	Operating Free-Air Temperature	0		70	°C

# ELECTRICAL CHARACTERISTICS OVER RECOMMENDED OPERATING FREE-AIR TEMPERATURE RANGE (Unless otherwise noted)

				IDT72V3611 Commercial tCLK = 15 ns			
Symbol	Parameter		Test Conditions	Min.	Тур.(1)	Max.	Unit
Vон	Output Logic "1" Voltage	VCC = 3.0V,	Iон = -4 mA	2.4	_	—	V
Vol	Output Logic "0" Voltage	VCC = 3.0V,	IOL = 8 mA	-	_	0.5	V
ILI	Input Leakage Current (Any Input)	VCC = 3.6V,	VI = VCC  or  0	-	—	±5	μA
Ilo	Output Leakage Current	VCC = 3.6V,	VO = VCC  or  O	-	—	±5	μA
ICC <sup>(2)</sup>	Standby Current	VCC = 3.6V,	VI = VCC - 0.2V  or  0	-	—	500	μA
Cin	InputCapacitance	VI = 0,	f = 1 MHz	-	4	_	рF
Соит	OutputCapacitance	Vo = 0,	f = 1 MHZ	-	8	_	pF

#### NOTES:

1. All typical values are at Vcc = 3.3V, TA =  $25^{\circ}C$ .

2. For additional Icc information, see Figure 1, Typical Characteristics: Supply Current (Icc) vs. Clock Frequency (fs).

### DETERMINING ACTIVE CURRENT CONSUMPTION AND POWER DISSIPATION

The ICC(f) data for the graph was taken while simultaneously reading and writing the FIFO on the IDT72V3611 with CLKA and CLKB operating at frequency fs. All data inputs and data outputs change state during each clock cycle to consume the highest supply current. Data outputs were disconnected to normalize the graph to a zero-capacitance load. Once the capacitance load per data-output channel is known, the power dissipation can be calculated with the equation below.

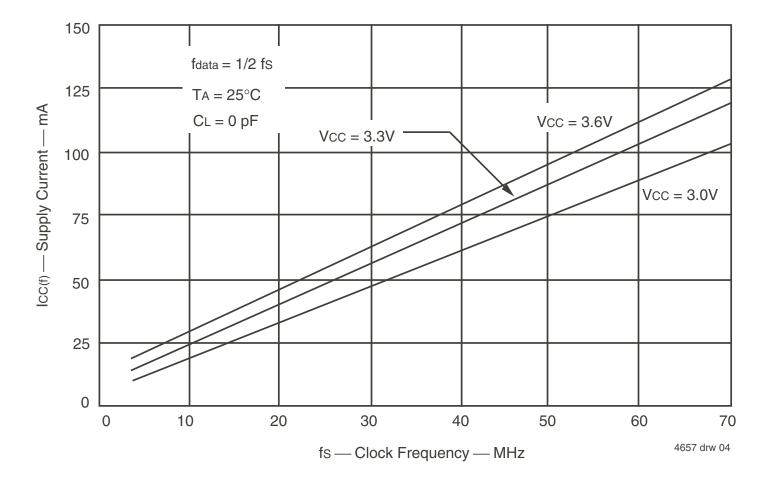
### CALCULATING POWER DISSIPATION

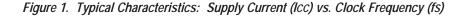
With ICC(f) taken from Figure 1, the maximum power dissipation (PT) of the IDT72V3611 may be calculated by:

 $PT = VCC \times ICC(f) + \Sigma(CL \times (VOH - VOL)^2 \times fO)$ Ν where: Ν number of outputs = 36 = Cl output capacitance load = switching frequency of an output fO = Vон output high-level voltage = Vol output low-level voltage =

When no read or writes are occurring on this device, the power dissipated by a single clock (CLKA or CLKB) input running at frequency fs is calculated by:

PT = VCC x fs x 0.025 mA/MHz







# TIMING REQUIREMENTS OVER RECOMMENDED RANGES OF SUPPLY VOLTAGE AND OPERATING FREE-AIR TEMPERATURES

		IDT72V3	IDT72V3611L15		
Symbol	Parameter	Min.	Max.	Unit	
fS	Clock Frequency, CLKA or CLKB	-	66.7	Mhz	
<b>t</b> CLK	Clock Cycle Time, CLKA or CLKB	15	_	Mhz	
tclkh	Pulse Duration, CLKA or CLKB HIGH	6	_	ns	
<b>t</b> CLKL	Pulse Duration, CLKA or CLKB LOW	6	-	ns	
tDS	Setup Time, A0-A35 before CLKA↑ and B0-B35 before CLKB↑	4	_	ns	
tens1	$\overline{CSA}$ , W/ $\overline{R}A$ , before CLKA $\uparrow$ ; $\overline{CSB}$ , W/ $\overline{R}B$ before CLKB $\uparrow$	6	_	ns	
tens2	ENA before CLKA <sup>↑</sup> ; ENB before CLKB <sup>↑</sup>	4	-	ns	
tens3	MBA before CLKA1; ENB before CLKB1	4	_	ns	
tpgs	Setup Time, ODD/EVEN and PGB before CLKB <sup>(1)</sup>	4	-	ns	
trsts	Setup Time, $\overline{\text{RST}}$ LOW before CLKA $\uparrow$ or CLKB $\uparrow^{(2)}$	5	_	ns	
tFSS	Setup Time, FS0 and FS1 before RST HIGH	5	_	ns	
tDH	Hold Time, A0-A35 after CLKA <sup>↑</sup> and B0-B35 after CLKB <sup>↑</sup>	1	_	ns	
tenh1	$\overline{\text{CSA}}$ , W/ $\overline{\text{RA}}$ after CLKA $\uparrow$ ; $\overline{\text{CSB}}$ , W/ $\overline{\text{RB}}$ after CLKB $\uparrow$	1	-	ns	
tenh2	ENA after CLKA <sup>↑</sup> ; ENB after CLKB <sup>↑</sup>	1		ns	
tenh3	MBA after CLKA <sup>↑</sup> ; MBB after CLKB <sup>↑</sup>	1		ns	
tpgh	Hold Time, ODD/EVEN and PGB after CLKB $\uparrow^{(1)}$	0	-	ns	
trsth	Hold Time, $\overline{\text{RST}}$ LOW after CLKA $\uparrow$ or CLKB $\uparrow^{(2)}$	6	-	ns	
tfsh	Hold Time, FS0 and FS1 after RST HIGH	4	-	ns	
tskew1(3)	Skew Time, between CLKA <sup>↑</sup> and CLKB <sup>↑</sup> for EF, FF	8	_	ns	
tskew2(3,4)	Skew Time, between CLKA $\uparrow$ and CLKB $\uparrow$ for $\overline{AE}$ , $\overline{AF}$	14	-	ns	

NOTES:

1. Only applies for a rising edge of CLKB that does a FIFO read.

2. Requirement to count the clock edge as one of at least four needed to reset a FIFO.

3. Skew time is not a timing constraint for proper device operation and is only included to illustrate the timing relationship between CLKA cycle and CLKB cycle.

4. Design simulated, not tested.

# SWITCHING CHARACTERISTICS OVER RECOMMENDED RANGES OF SUPPLY VOLTAGE AND OPERATING FREE-AIR TEMPERATURE, CL = 30 pF

		IDT72V	IDT72V3611L15		
Symbol	Parameter	Min.	Max.	Unit	
fS	Clock Frequency, CLKA or CLKB	-	66.7	MHz	
tA	Access Time, CLKB <sup>↑</sup> to B0-B35	2	10	ns	
twff	Propagation Delay Time, CLKA↑ to FF	2	10	ns	
tref	Propagation Delay Time, CLKB↑ to EF	2	10	ns	
<b>t</b> PAE	Propagation Delay Time, CLKB↑ to AE	2	10	ns	
tPAF	Propagation Delay Time, CLKA $\uparrow$ to $\overline{AF}$	2	10	ns	
<b>t</b> PMF	Propagation Delay Time, CLKA <sup>↑</sup> to MBF1 LOW or MBF2 HIGH and CLKB <sup>↑</sup> to MBF2 LOW or MBF1 HIGH	1	9	ns	
<b>t</b> PMR	Propagation Delay Time, CLKA $\uparrow$ to B0-B35 $^{(1)}$ and CLKB $\uparrow$ to A0-A35 $^{(2)}$	2	10	ns	
tMDV	Propagation Delay Time, MBB to B0-B35 Valid	1	10	ns	
<b>t</b> PDPE	Propagation Delay Time, A0-A35 Valid to PEFA Valid; B0-B35 Valid to PEFB Valid	2	10	ns	
<b>t</b> POPE	Propagation Delay Time, ODD/EVEN to PEFA and PEFB	2	10	ns	
tpopb <sup>(3)</sup>	Propagation Delay Time, ODD/EVEN to Parity Bits (A8, A17, A26, A35) and (B8, B17, B26, B35)	2	10	ns	
<b>t</b> PEPE	Propagation Delay Time, CSA, ENA, W/RA, MBA, or PGA to PEFA; CSB, ENB, W/RB, MBB, or PGB to PEFB	1	10	ns	
tPEPB <sup>(3)</sup>	Propagation Delay Time, CSA, ENA W/RA, MBA, or PGA to Parity Bits (A8, A17, A26, A35); CSB, ENB, W/RB, MBB, or PGB to Parity Bits (B8, B17, B26, B35)	2	10	ns	
trsf	Propagation Delay Time, RST to AE LOW and (AF, MBF1, MBF2) HIGH	1	15	ns	
ten	Enable Time, CSA and W/RA LOW to A0-A35 Active and CSB LOW and W/RB HIGH to B0-B35 Active	2	10	ns	
tdis	Disable Time, $\overline{CSA}$ or W/ $\overline{RA}$ HIGH to A0-A35 at high impedance and $\overline{CSB}$ HIGH or $\overline{W}/\overline{RB}$ LOW to B0-B35 at high impedance	1	9	ns	

NOTES:

1. Writing data to the mail1 register when the B0-B35 outputs are active and MBB is HIGH.

2. Writing data to the mail2 register when the A0-A35 outputs are active and MBA is HIGH.

3. Only applies when reading data from a mail register.

# SIGNAL DESCRIPTION

## RESET (RST)

The IDT72V3611 is reset by taking the Reset (RST) input LOW for at least four port-A clock (CLKA) and four port B clock (CLKB) LOW-to-HIGH transitions. The reset input can switch asynchronously to the clocks. A device reset initializes the internal read and write pointers of the FIFO and forces the Full Flag (FF) LOW, the Empty Flag (EF) LOW, the Almost-Emptyflag (AE) LOW, and the Almost-Full flag (AF) HIGH. A reset also forces the Mailbox Flags (MBF1, MBF2) HIGH. After a reset, FF is set HIGH after two LOW-to-HIGH transitions of CLKA. The device must be reset after power up before data is written to its memory.

A LOW-to-HIGH transition on the  $\overline{RST}$  input loads the Almost-Full and Almost-Empty Offset register (X) with the value selected by the Flag Select

## **TABLE 1 – FLAG PROGRAMMING**

Almost-Full and Almost-Empty Flag Offset Register (X)	FS1	FS0	RST
16	Н	Н	$\uparrow$
12	Н	L	$\uparrow$
8	L	Н	$\uparrow$
4	L	L	$\uparrow$

(FS0, FS1) inputs. The values that can be loaded into the register are shown in Table 1. For the relevant Reset timing and preset value loading timing diagram, see Figure 2. The relevant Write timing diagram for Port A can be found in Figure 3.

#### FIFO WRITE/READ OPERATION

The state of the port-A data (A0-A35) outputs is controlled by the port-A Chip Select ( $\overline{CSA}$ ) and the port-A Write/Read select ( $W/\overline{R}A$ ). The A0-A35 outputs are in the high-impedance state when either  $\overline{CSA}$  or  $W/\overline{R}A$  is HIGH. The A0-A35 outputs are active when both  $\overline{CSA}$  and  $W/\overline{R}A$  are LOW. Data is loaded into the FIFO from the A0-A35 inputs on a LOW-to-HIGH transition of CLKA when  $\overline{CSA}$  is LOW,  $W/\overline{R}A$  is HIGH, ENA is HIGH, MBA is LOW, and  $\overline{FF}$  is HIGH (see Table 2).

The port-B control signals are identical to those of port A. The state of the port-B data (B0-B35) outputs is controlled by the port-B Chip Select ( $\overline{CSB}$ ) and the port-B Write/Read select ( $W/\overline{RB}$ ). The B0-B35 outputs are in the high-impedance state when either  $\overline{CSB}$  or  $W/\overline{RB}$  is HIGH. The B0-B35 outputs are active when both  $\overline{CSB}$  and  $W/\overline{RB}$  are LOW. Data is read from the FIFO to the B0-B35 outputs by a LOW-to-HIGH transition of CLKB when  $\overline{CSB}$  is LOW,  $W/\overline{RB}$  is LOW, ENB is HIGH, MBB is LOW, and  $\overline{EF}$  is HIGH (see Table 3). The relevant Read timing diagram for Port B can be found in Figure 4.

The setup and hold-time constraints to the port clocks for the port Chip Selects (CSA, CSB) and Write/Read selects (W/RA, W/RB) are only for enabling write and read operations and are not related to HIGH-impedance control of the data outputs. If a port enable is LOW during a clock cycle, the port's Chip Select and Write/Read select can change states during the setup and hold-time window of the cycle.

## TABLE 2 - PORT-A ENABLE FUNCTION TABLE

CSA	W/RA	ENA	MBA	CLKA	Data A (A0-A35) I/O	Port Functions
Н	Х	Х	Х	Х	Input	None
L	Н	L	Х	Х	Input	None
L	Н	Н	L	$\uparrow$	Input	FIFOWrite
L	Н	Н	Н	$\uparrow$	Input	Mail1 Write
L	L	L	L	Х	Output	None
L	L	Н	L	$\uparrow$	Output	None
L	L	L	Н	Х	Output	None
L	L	Н	Н	↑	Output	Mail2 Read (set MBF2 HIGH)

## TABLE 3 – PORT-B ENABLE FUNCTION TABLE

CSB	W/RB	ENB	MBB	CLKB	Data B (B0-B35) I/O	Port Functions
Н	Х	Х	Х	Х	Input	None
L	Н	L	Х	Х	Input	None
L	Н	Н	L	$\uparrow$	Input	None
L	Н	Н	Н	$\uparrow$	Input	Mail2 Write
L	L	L	L	Х	Output	None
L	L	Н	L	$\uparrow$	Output	FIFO Read
L	L	L	Н	Х	Output	None
L	L	Н	Н	$\uparrow$	Output	Mail1 Read (set MBF1 HIGH)



## SYNCHRONIZED FIFO FLAGS

Each FIFO flag is synchronized to its port clock through two flip-flop stages. This is done to improve the flags' reliability by reducing the probability of metastable events on their outputs when CLKA and CLKB operate asynchronously to one another. FF and AF are synchronized to CLKA. EF and AE are synchronized to CLKB. Table 4 shows the relationship of the flags to the level of FIFO fill.

#### EMPTY FLAG (EF)

The FIFO Empty Flag is synchronized to the port clock that reads data from its array (CLKB). When the  $\overline{\text{EF}}$  is HIGH, new data can be read to the FIFO output register. When the  $\overline{\text{EF}}$  is LOW, the FIFO is empty and attempted FIFO reads are ignored.

The FIFO read pointer is incremented each time a new word is clocked to its output register. The state machine that controls an EF monitors a write pointer and read pointer comparator that indicates when the FIFO memory status is empty, empty+1, or empty+2. A word written to the FIFO can be read to the FIFO output register in a minimum of three port-B clock (CLKB) cycles. Therefore, an EF is LOW if a word in memory is the next data to be sent to the FIFO output register and two CLKB cycles have not elapsed since the time the word was written. The EF of the FIFO is set HIGH by the second LOW-to-HIGH transition of CLKB, and the new data word can be read to the FIFO output register in the following cycle.

A LOW-to-HIGH transition on CLKB begins the first synchronized cycle of a write if the clock transition occurs at time tskew1 or greater after the write. Otherwise, the subsequent CLKB cycle can be the first synchronization cycle (see Figure 5).

### FULL FLAG (FF)

The FIFO Full Flag is synchronized to the port clock that writes data to its array (CLKA). When the FF is HIGH, a FIFO memory location is free to receive new data. No memory locations are free when the FF is LOW and attempted writes to the FIFO are ignored.

Each time a word is written to the FIFO, its write pointer is incremented. The state machine that controls the  $\overline{FF}$  monitors a write pointer and read pointer comparator that indicates when the FIFO memory status is full, full-1, or full-2. From the time a word is read from the FIFO, its previous memory location is ready to be written in a minimum of three port-A clock cycles. Therefore, a  $\overline{FF}$  is LOW if less than two CLKA cycles have elapsed since the next memory write location has been read. The second LOW-to-HIGH transition on CLKA after

## TABLE 4 – FIFO FLAG OPERATION

	Synch	Synchronized		onized
Number of Words	to C	CLKB	to CL	KA
in the FIFO	ĒF	EF AE		FF
0	L	L	Н	Н
1 to X	Н	L	Н	Н
(X+1) to [64-(X+1)]	Н	Н	Н	Н
(64-X) to 63	Н	Н	L	Н
64	Н	Н	L	L

NOTE:

1. X is the value in the Almost-Empty flag and Almost-Full flag register.

the read sets the  $\overline{\rm FF}$  HIGH and data can be written in the following clock cycle.

ALOW-to-HIGH transition on CLKA begins the first synchronization cycle of a read if the clock transition occurs at time tskEw1 or greater after the read. Otherwise, the subsequent clock cycle can be the first synchronization cycle (see Figure 6).

#### ALMOST-EMPTY FLAG (AE)

The FIFO Almost-Empty flag is synchronized to the port clock that reads data from its array (CLKB). The state machine that controls the  $\overline{AE}$  flag monitors a write pointer and read pointer comparator that indicates when the FIFO memory status is almost-empty, almost-empty+1, or almost-empty+2. The almost-empty state is defined by the value of the Almost-Full and Almost-Empty Offset register (X). This register is loaded with one of four preset values during a device reset (see the Reset section). The  $\overline{AE}$  flag is LOW when the FIFO contains X or less words in memory and is HIGH when the FIFO contains (X+1) or more words.

Two LOW-to-HIGH transitions on the port-B clock (CLKB) are required after a FIFO write for the  $\overline{AE}$  flag to reflect the new level of fill. Therefore, the  $\overline{AE}$  flag of a FIFO containing (X+1) or more words remains LOW if two CLKB cycles have not elapsed since the write that filled the memory to the (X+1) level. The  $\overline{AE}$  flag is set HIGH by the second CLKB LOW-to-HIGH transition after the FIFO write that fills memory to the (X+1) level. A LOW-to-HIGH transition on CLKB begins the first synchronization cycle if it occurs at time tskEw2 or greater after the write that fills the FIFO to (X+1) words. Otherwise, the subsequent CLKB cycle can be the first synchronization cycle (see Figure 7).

#### ALMOST-FULL FLAG (AF)

The FIFO Almost-Full flag is synchronized to the port clock that writes data to its array (CLKA). The state machine that controls an AF flag monitors a write pointer and read pointer comparator that indicates when the FIFO memory status is almost-full, almost-full-1, or almost-full-2. The almost-full state is defined by the value of the Almost-Full and Almost-Empty Offset register (X). This register is loaded with one of four preset values during a device reset (see the Reset section). The AF flag is LOW when the FIFO contains (64-X) or more words in memory and is HIGH when the FIFO contains [64-(X+1)] or less words.

Two LOW-to-HIGH transitions on the port-A clock (CLKA) are required after a FIFO read for the  $\overline{AF}$  flag to reflect the new level of fill. Therefore, the  $\overline{AF}$  flag of a FIFO containing [64-(X+1)] or less words remains LOW if two CLKA cycles have not elapsed since the read that reduced the number of words in memory to [64-(X+1)]. The  $\overline{AF}$  flag is set HIGH by the second CLKA LOW-to-HIGH transition after the FIFO read that reduces the number of words in memory to [64-(X+1)]. A LOW-to-HIGH transition on CLKA begins the first synchronization cycle if it occurs at time tskEw2 or greater after the read that reduces the number of words in memory to [64-(X+1)]. Otherwise, the subsequent CLKA cycle can be the first synchronization cycle (see Figure 8).

#### MAILBOX REGISTERS

Two 36-bit bypass registers are on the IDT72V3611 to pass command and control information between port A and port B. The Mailbox select (MBA, MBB) inputs choose between a mail register and a FIFO for a port data transfer operation. A LOW-to-HIGH transition on CLKA writes A0-A35 data to the mail1 register when port-A write is selected by  $\overline{CSA}$ , W/ $\overline{RA}$ , and  $\overline{ENA}$  with MBA HIGH. A LOW-to-HIGH transition on CLKB writes B0-B35 data to the mail2 register when port-B write is selected by  $\overline{CSB}$ , W/ $\overline{RB}$ , and  $\overline{ENB}$  with MBB HIGH. Writing data to a mail register sets its corresponding flag (MBF1 or MBF2) LOW. Attempted writes to a mail register are ignored while its mail flag is LOW.

When the port-B data (B0-B35) outputs are active, the data on the bus comes from the FIFO output register when the port-B Mailbox select (MBB) input

is LOW and from the mail1 register when MBB is HIGH. Mail2 data is always present on the port-A data (A0-A35) outputs when they are active. The Mail1 Register Flag (MBF1) is set HIGH by a LOW-to-HIGH transition on CLKB when a port-B read is selected by CSB, W/RB, and ENB with MBB HIGH. The Mail2 Register Flag (MBF2) is set HIGH by a LOW-to-HIGH transition on CLKA when a port-A read is selected by CSA, W/RA, and ENA with MBA HIGH. The data in a mail register remains intact after it is read and changes only when new data is written to the register. For relevant mail register and mail register flag timing diagrams, see Figure 9 and Figure 10.

#### PARITY CHECKING

The port-A (A0-A35) inputs and port-B (B0-B35) inputs each have four parity trees to check the parity of incoming (or outgoing) data. A parity failure on one or more bytes of the input bus is reported by a LOW level on the port Parity Error Flag (PEFA, PEFB). Odd or even parity checking can be selected, and the Parity Error Flags can be ignored if this feature is not desired.

Parity status is checked on each input bus according to the level of the Odd/ Even parity (ODD/EVEN) select input. A parity error on one or more bytes of a port is reported by a LOW level on the corresponding port Parity Error Flag (PEFA, PEFB) output. Port-A bytes are arranged as A0-A8, A9-A17, A18-A26, and A27-A35, and port-B bytes are arranged as B0-B8, B9-B17, B18-B26, and B27-B35. When Odd/Even parity is selected, a port Parity Error Flag (PEFA, PEFB) is LOW if any byte on the port has an odd/even number of LOW levels applied to its bits.

The four parity trees used to check the A0-A35 inputs are shared by the mail2 register when parity generation is selected for port-A reads (PGA=HIGH). When port-A read from the mail2 register with parity generation is selected with  $\overline{CSA}$  LOW, ENA HIGH, W/RA LOW, MBA HIGH, and PGA HIGH, the port-A Parity Error Flag (PEFA) is held HIGH regardless of the levels applied to the A0-A35 inputs. Likewise, the parity trees used to check the B0-B35 inputs are shared by the mail1 register when parity generation is selected for port-B reads (PGB=HIGH). When a port-B read from the mail1 register with

parity generation is selected with  $\overline{\text{CSB}}$  LOW, ENB HIGH, W/RB LOW, MBB HIGH, and PGB HIGH, the port-B Parity Error Flag ( $\overline{\text{PEFB}}$ ) is held HIGH regardless of the levels applied to the B0-B35 inputs.

#### PARITY GENERATION

A HIGH level on the port-A Parity Generate select (PGA) or port-B Parity Generate select (PGB) enables the IDT72V3611 to generate parity bits for port reads from a FIFO or mailbox register. Port-A bytes are arranged as A0-A8, A9-A17, A18-A26, and A27-A35, with the most significant bit of each byte used as the parity bit. Port-B bytes are arranged as B0-B8, B9-B17, B18-B26, and B27-B35, with the most significant bit of each byte used as the parity bit. A write to a FIFO or mail register stores the levels applied to all thirty-six inputs regardless of the state of the Parity Generate select (PGA, PGB) inputs. When data is read from a port with parity generation selected, the lower eight bits of each byte are used to generate a parity bit according to the level on the ODD/ EVEN select. The generated parity bits are substituted for the levels originally written to the most significant bits of each byte as the word is read to the data outputs.

Parity bits for FIFO data are generated after the data is read from the FIFO RAM and before the data is written to the output register. Therefore, the port-B Parity Generate select (PGB) and ODD/EVEN have setup and hold time constraints to the port-B clock (CLKB) for a rising edge of CLKB used to read a new word to the FIFO output register.

The circuit used to generate parity for the mail1 data is shared by the port-B bus (B0-B35) to check parity and the circuit used to generate parity for the mail2 data is shared by the port-A bus (A0-A35) to check parity. The shared parity trees of a port are used to generate parity bits for the data in a mail register when the port Write/Read select (W/RA, W/RB) input is LOW, the port Mail select (MBA, MBB) input is HIGH, Chip Select (CSA, CSB) is LOW, Enable (ENA, ENB) is HIGH, and the port Parity Generate select (PGA, PGB) is HIGH. Generating parity for mail register data does not change the contents of the register (see Figure 13 and Figure 14).

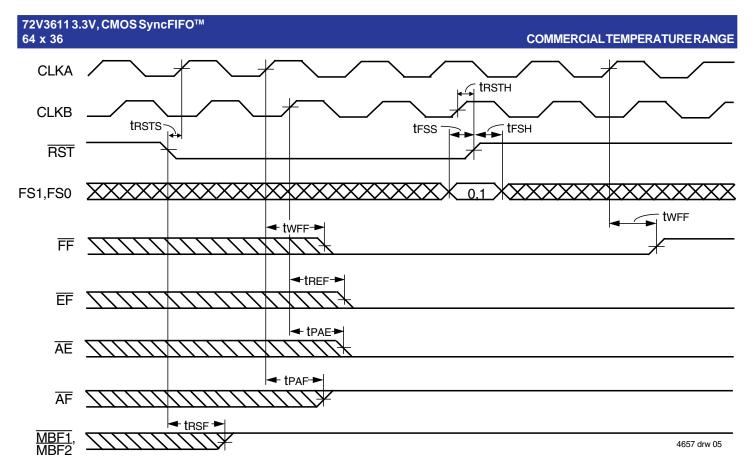


Figure 2. Device Reset and Loading the X Register with the Value of Eight

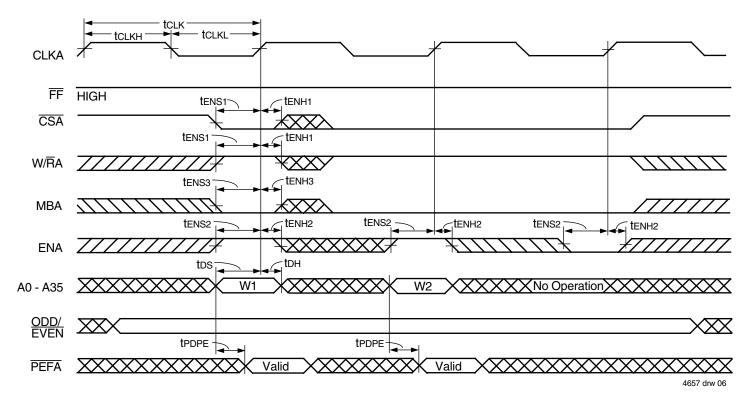


Figure 3. FIFO Write Cycle Timing



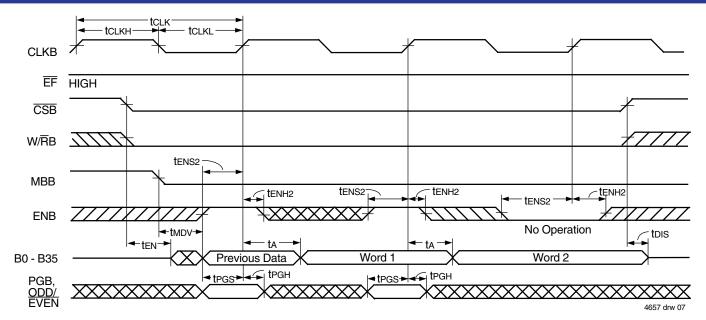
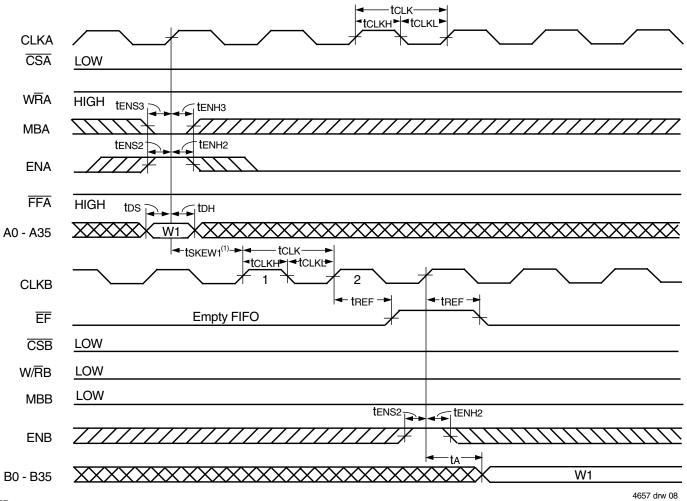


Figure 4. FIFO Read Cycle Timing

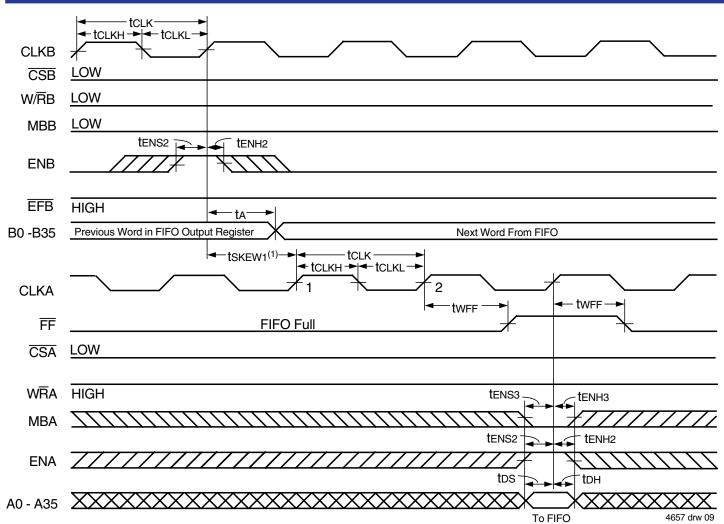


NOTE:

1. tskew1 is the minimum time between a rising CLKA edge and a rising CLKB edge for  $\overline{EF}$  to transition HIGH in the next CLKB cycle. If the time between the rising CLKA edge and rising CLKB edge is less than tskew1, then the transition of  $\overline{EF}$  HIGH may occur one CLKB cycle later than shown.

Figure 5. EF Flag Timing and First Data Read when the FIFO is Empty

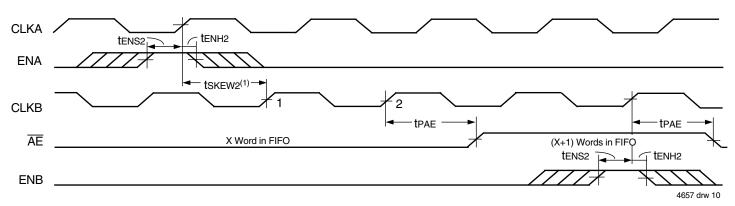




#### NOTE:

1. tskew1 is the minimum time between a rising CLKB edge and a rising CLKA edge for FF to transition HIGH in the next CLKA cycle. If the time between the rising CLKB edge and rising CLKA edge is less than tskew1, then the transition of FF HIGH may occur one CLKA cycle later than shown.





NOTES:

1. tskEw2 is the minimum time between a rising CLKA edge and a rising CLKB edge for  $\overline{AE}$  to transition HIGH in the next CLKB cycle. If the time between the rising CLKA edge and rising CLKB edge is less than tskEw2, then  $\overline{AE}$  may transition HIGH one CLKB cycle later than shown.

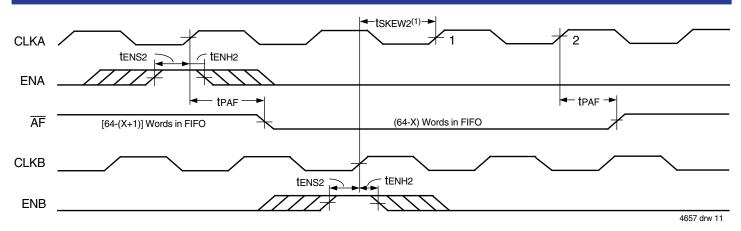
2. FIFO write ( $\overline{CSA}$  = L, W/ $\overline{R}A$  = H, MBA = L), FIFO read ( $\overline{CSB}$  = L, W/ $\overline{R}B$  = L, MBB = L).

#### Figure 7. Timing for AE when the FIFO is Almost-Empty



#### 72V36113.3V, CMOS SyncFIFO<sup>™</sup> 64 x 36

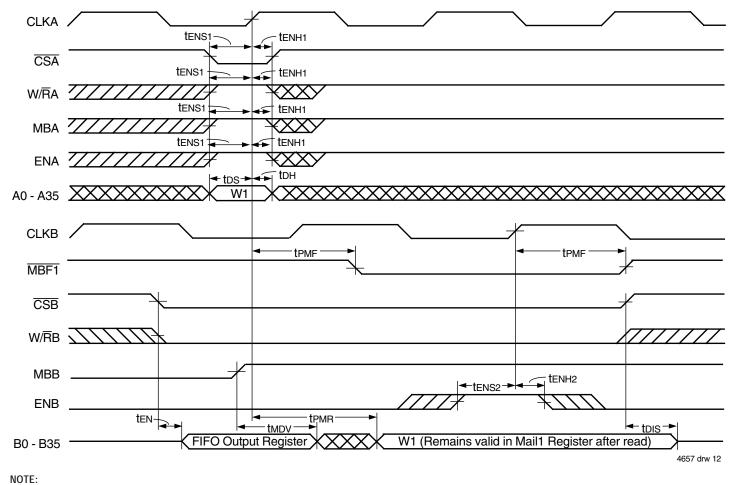
#### COMMERCIALTEMPERATURERANGE



#### NOTES:

- 1. tskew2 is the minimum time between a rising CLKA edge and a rising CLKB edge for  $\overline{AF}$  to transition HIGH in the next CLKA cycle. If the time between the rising CLKA edge and rising CLKB edge is less than tskew2, then  $\overline{AF}$  may transition HIGH one CLKA cycle later than shown.
- 2. FIFO write ( $\overline{CSA}$  = L, W/ $\overline{RA}$  = H, MBA = L), FIFO read ( $\overline{CSB}$  = L, W/ $\overline{RB}$  = L, MBB = L).

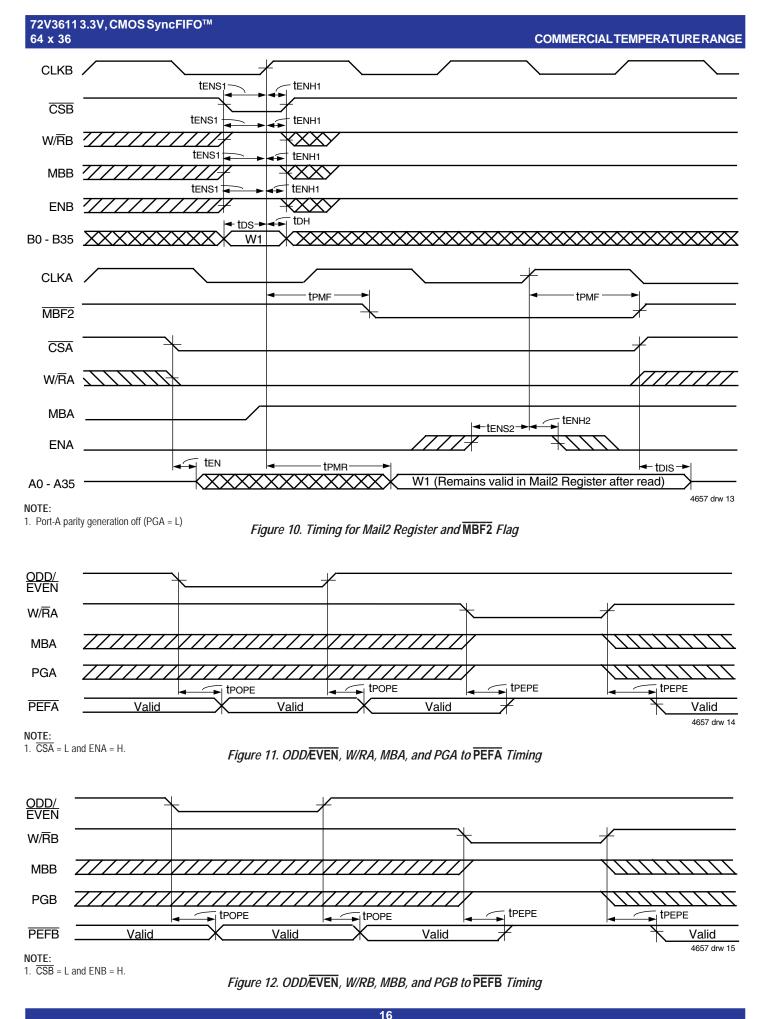
Figure 8. Timing for AF when the FIFO is Almost-Full



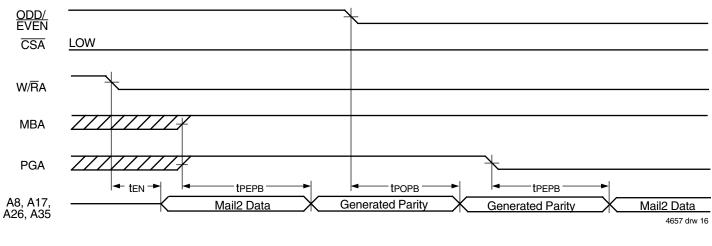
1. Port-B parity generation off (PGB = L)

#### Figure 9. Timing for Mail1 Register and MBF1 Flag



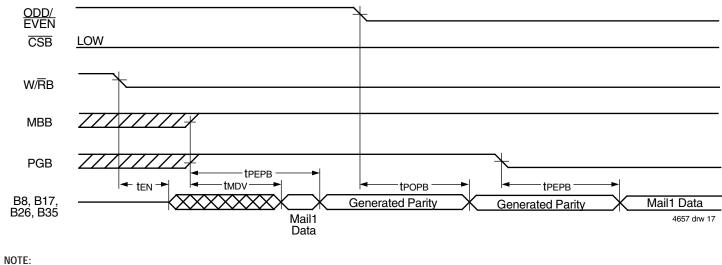






**NOTE:** 1. ENA = H.

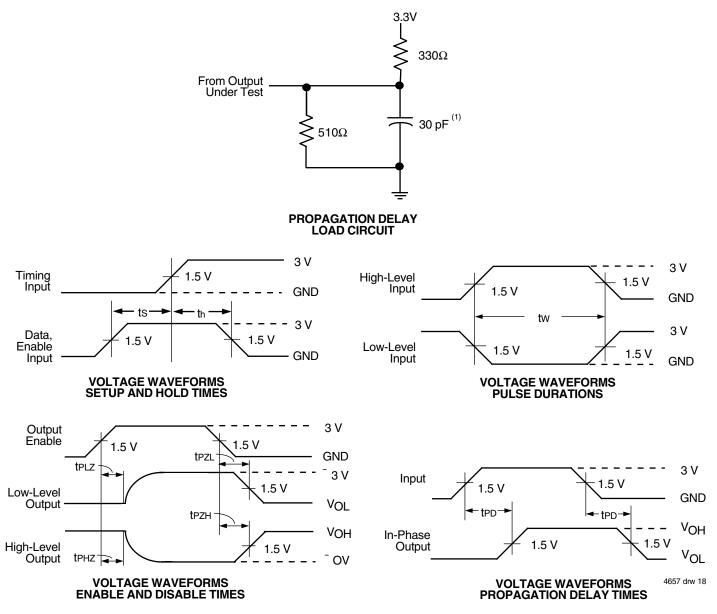
Figure 13. Parity Generation Timing when reading from the Mail2 Register



1. ENB = H.

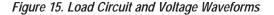
Figure 14. Parity Generation Timing when reading from the Mail1 Register

## PARAMETER MEASUREMENT INFORMATION

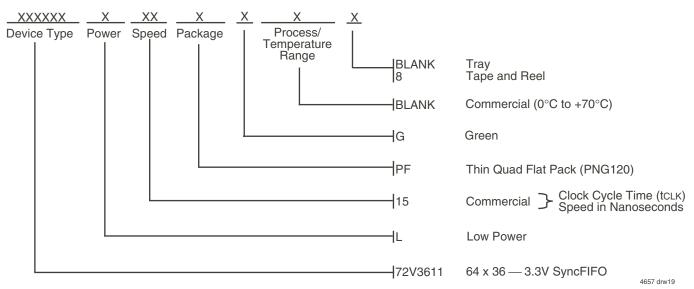




1. Includes probe and jig capacitance.



# ORDERING INFORMATION



## ORDERABLE PART INFORMATION

Speed (ns)	Orderable Part ID	Pkg. Code	Pkg. Type	Temp. Grade
15	72V3611L15PFG	PNG120	TQFP	С
	72V3611L15PFG8	PNG120	TQFP	С

# DATASHEET DOCUMENT HISTORY

07/10/2000	pg. 1
05/27/2003	pg. 6.
06/07/2005	pgs. 1, 2, 3 and 20.
02/10/2009	pg. 20.
11/07/2013	pgs. 1, 2, 5, 7, 8, 10 and 19.
01/09/2014	pg. 2.
07/15/2019	pg. 1, 2 and 19.
02/10/2020	pgs. 1-20.

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